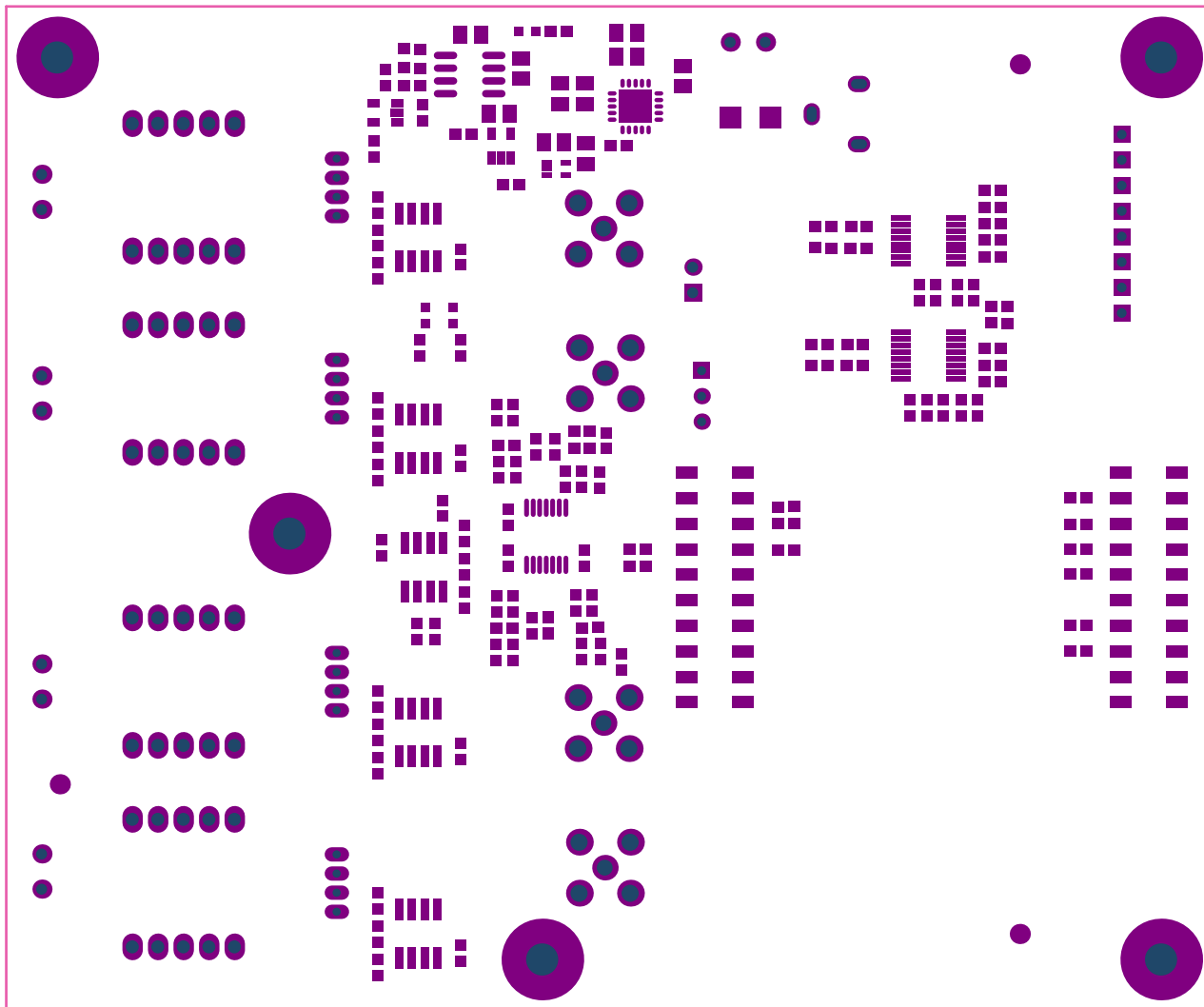
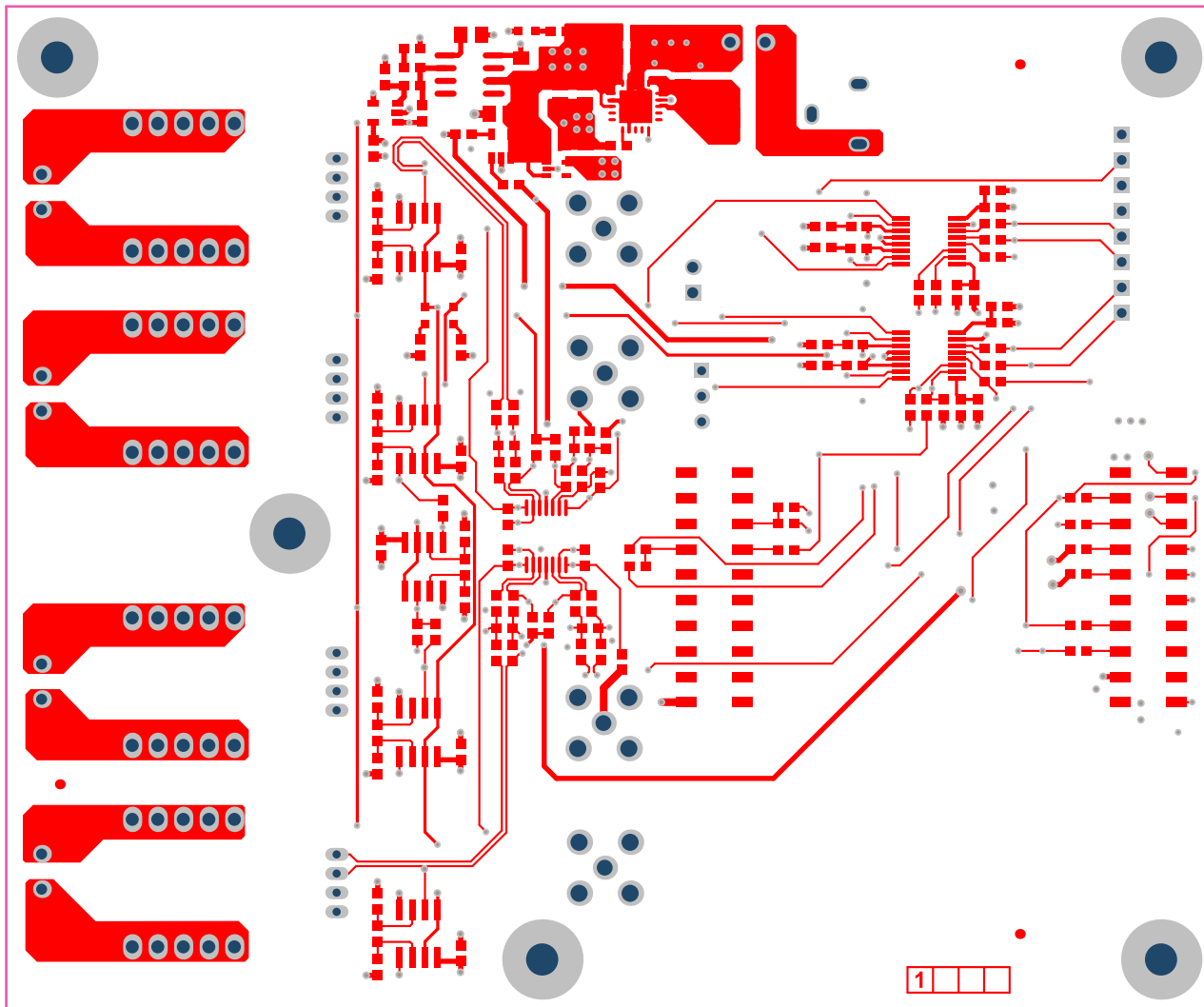

TEXAS INSTRUMENTS
TIDA-00208
REV: E2

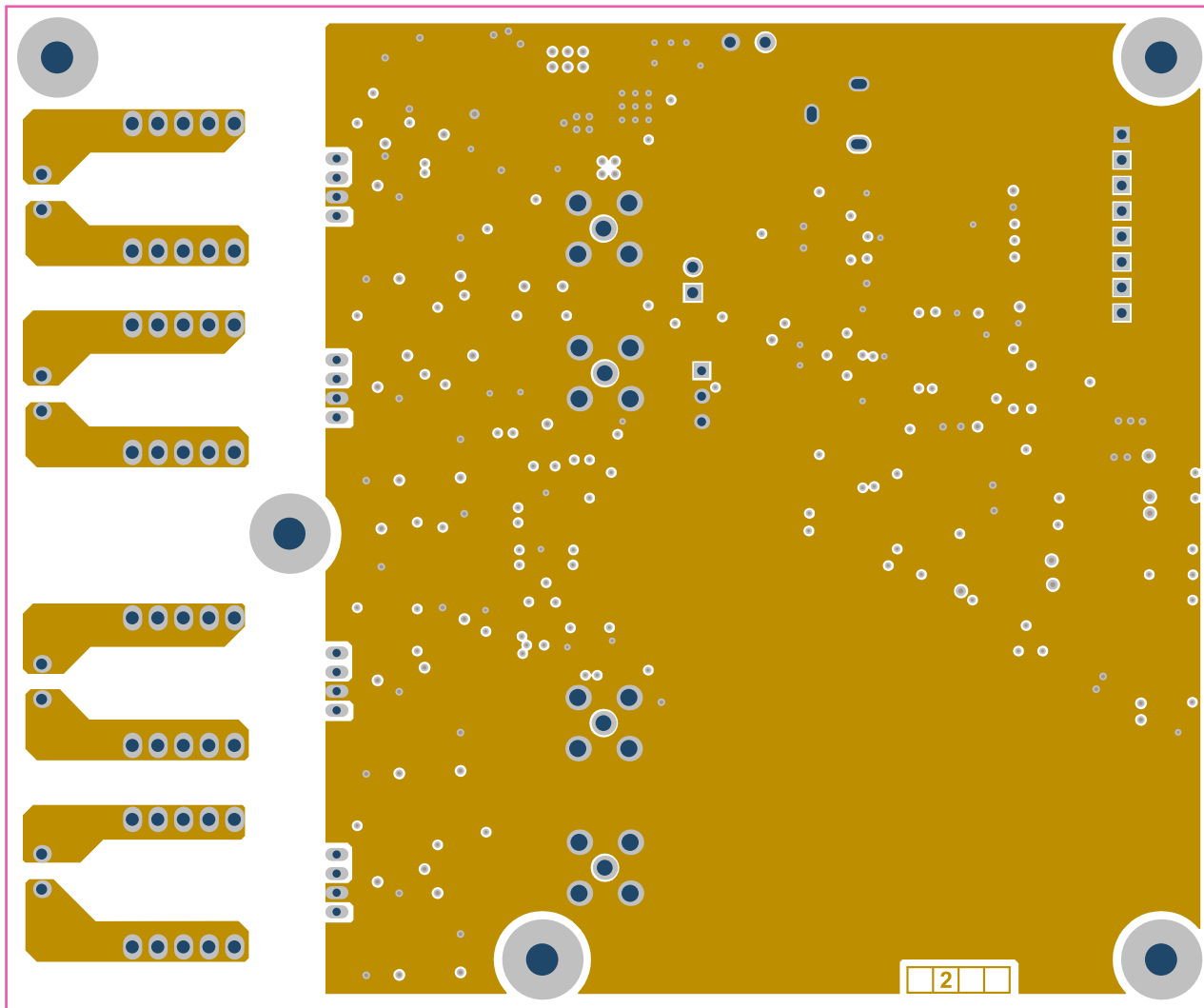
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/16/2014 12:36:56 PM	TEXAS INSTRUMENTS	



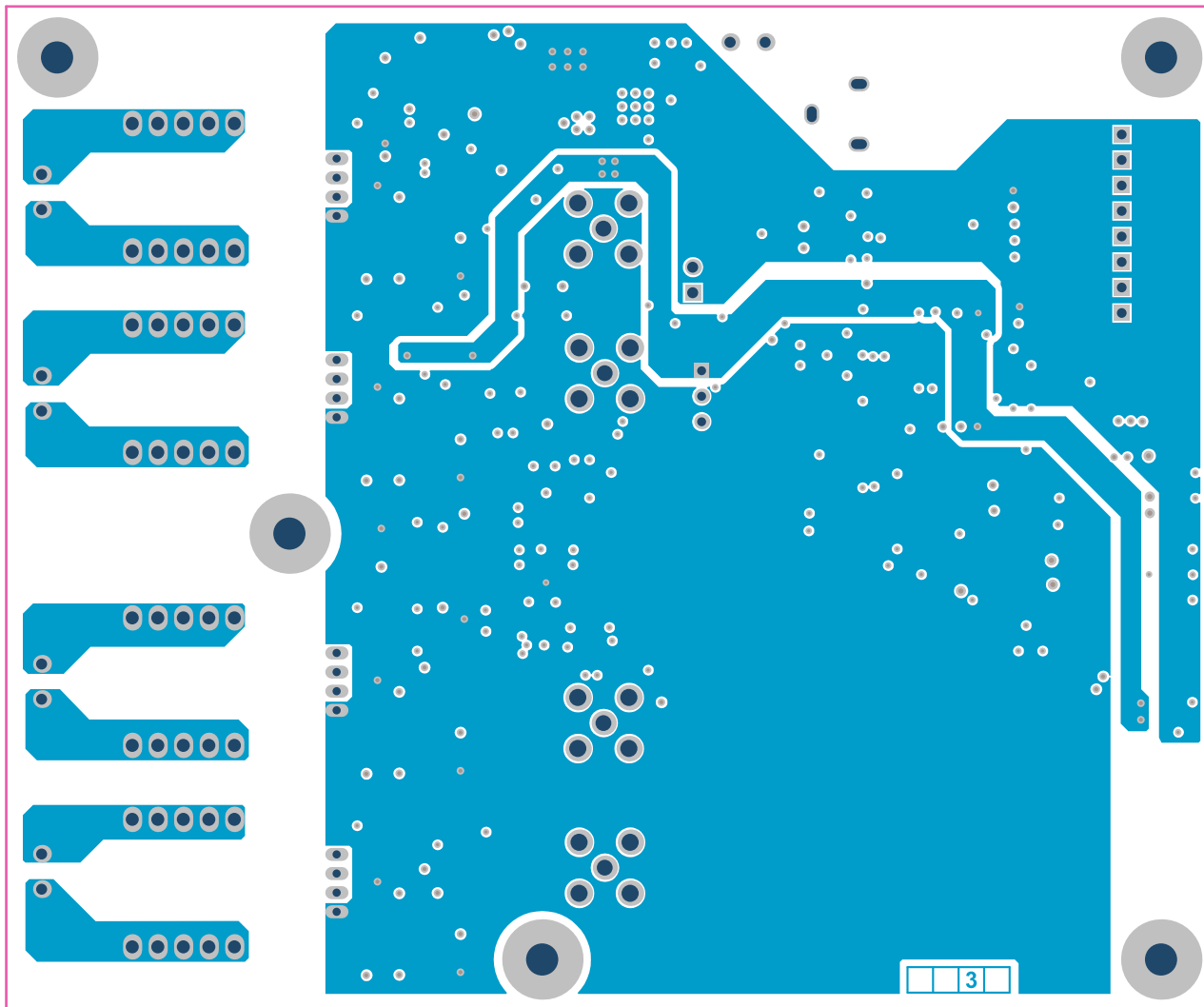
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 10/16/2014 12:36:57 PM	TEXAS INSTRUMENTS	



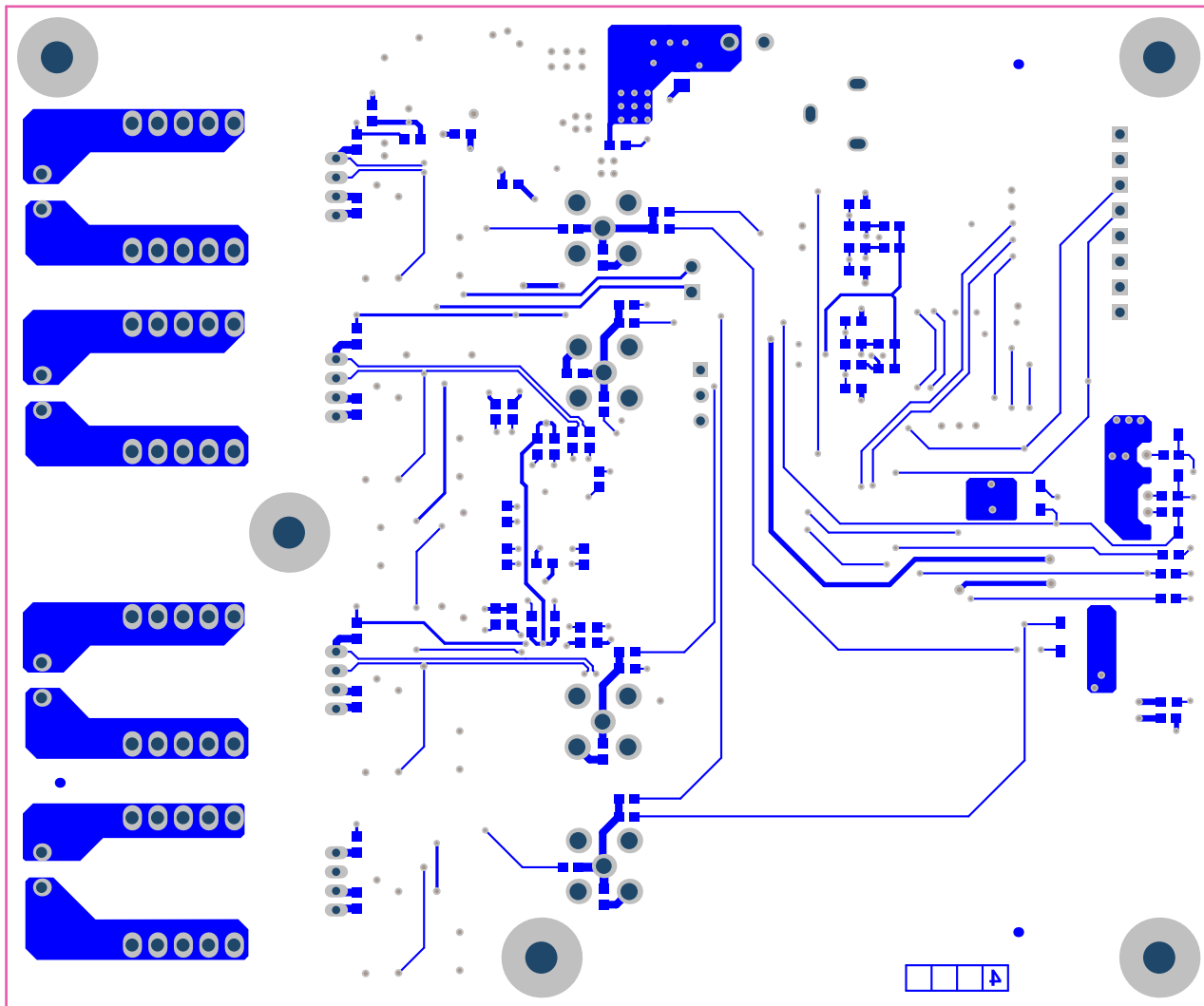
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
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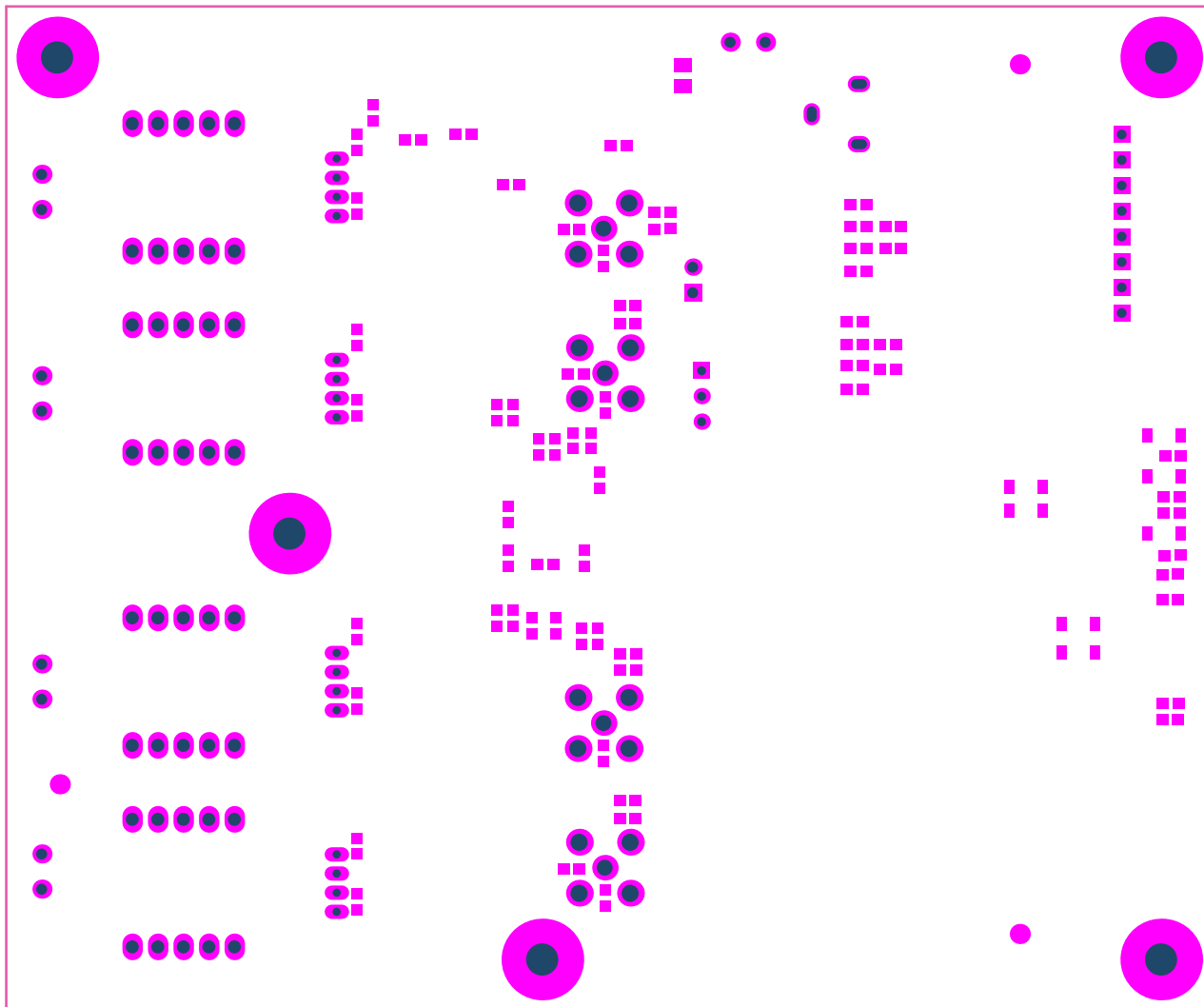
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LAYER NAME = MidLayer1			
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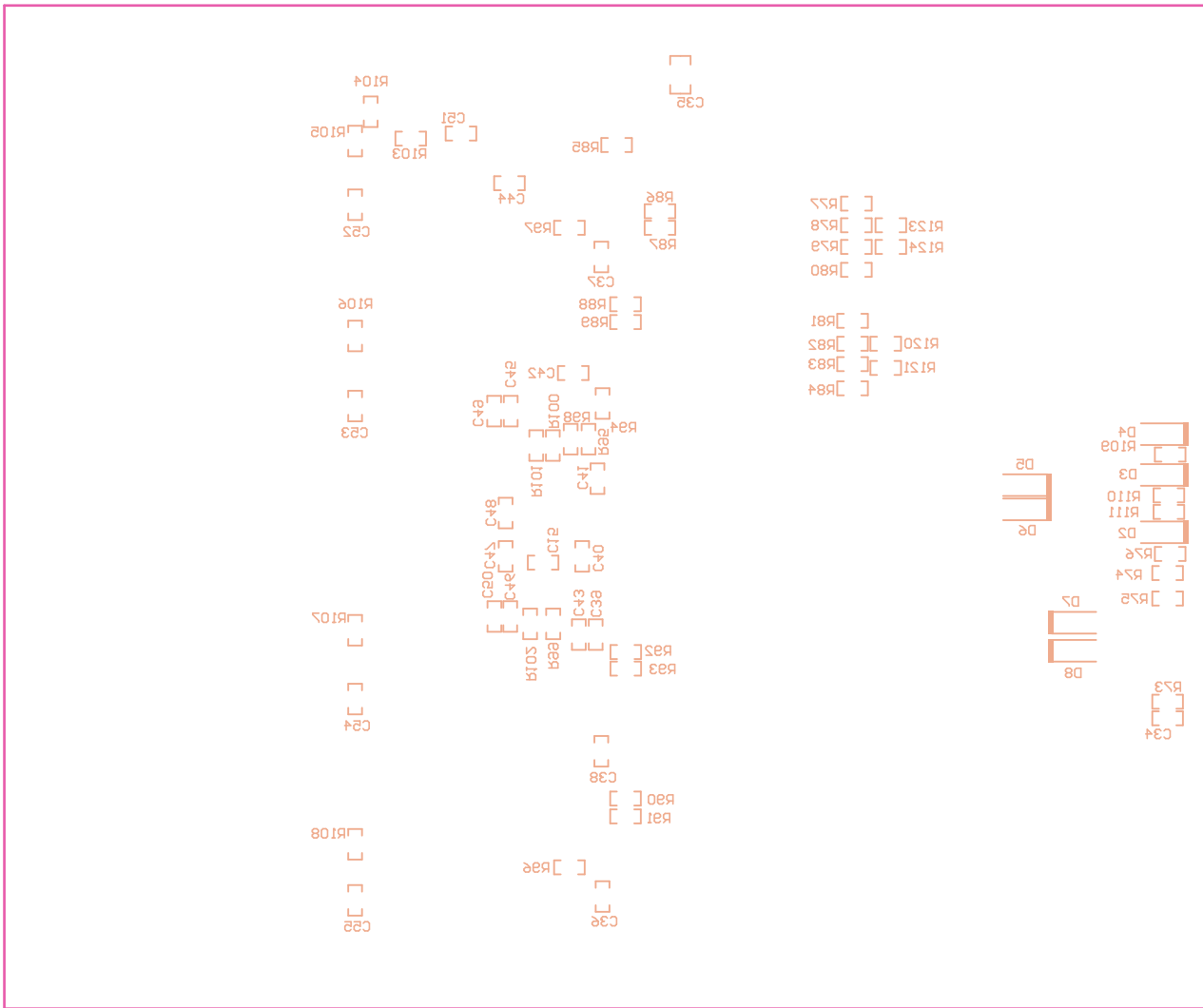
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = MidLayer2	GENERATED : 10/16/2014 12:36:58 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 10/16/2014 12:36:59 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/16/2014 12:36:59 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/16/2014 12:37:00 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00208	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = Board Outline	GENERATED : 10/16/2014 12:37:00 PM	TEXAS INSTRUMENTS	

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